

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIV)

# TPCA8024

Lithium-Ion Battery Applications  
 Notebook PC Applications  
 Portable Equipment Applications

Unit: mm

- Small footprint due to a small and thin package
- Low drain-source ON-resistance:  $R_{DS(ON)} = 3.5\text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 72\text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 10\text{ }\mu\text{A}$  (max) ( $V_{DS} = 30\text{ V}$ )
- Enhancement mode:  $V_{th} = 1.3\text{ to }2.5\text{ V}$  ( $V_{DS} = 10\text{ V}$ ,  $I_D = 1\text{ mA}$ )

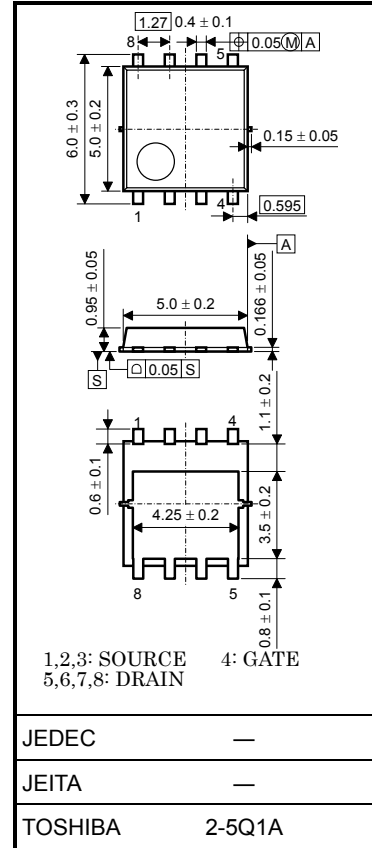
### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	30	V
Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )		$V_{DGR}$	30	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	DC (Note 1)	$I_D$	35	A
	Pulse (Note 1)	$I_{DP}$	105	
Drain power dissipation ( $T_c=25^\circ\text{C}$ )		$P_D$	35	W
Drain power dissipation ( $t = 10\text{ s}$ ) (Note 2a)		$P_D$	2.8	W
Drain power dissipation ( $t = 10\text{ s}$ ) (Note 2b)		$P_D$	1.6	W
Single pulse avalanche energy (Note 3)		$E_{AS}$	159	mJ
Avalanche current		$I_{AR}$	35	A
Repetitive avalanche energy ( $T_c=25^\circ\text{C}$ ) (Note 4)		$E_{AR}$	3.5	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 to 150	$^\circ\text{C}$

Note: For Note 1 to 4, refer to the next page.

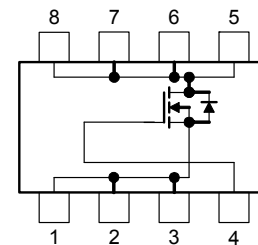
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.069 g (typ.)

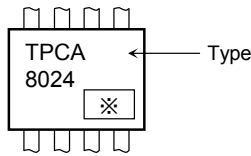
### Circuit Configuration



## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case ( $T_c=25^\circ\text{C}$ )	$R_{th(ch-c)}$	3.57	$^\circ\text{C/W}$
Thermal resistance, channel to ambient ( $t = 10\text{ s}$ ) (Note 2a)	$R_{th(ch-a)}$	44.6	$^\circ\text{C/W}$
Thermal resistance, channel to ambient ( $t = 10\text{ s}$ ) (Note 2b)	$R_{th(ch-a)}$	78.1	$^\circ\text{C/W}$

## Marking (Note 5)

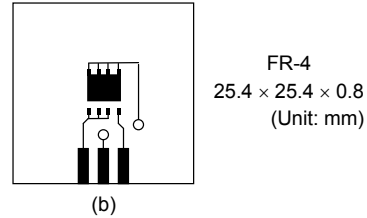
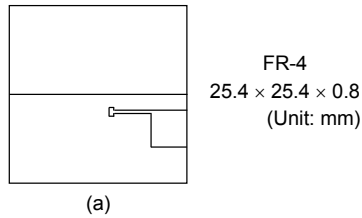


Note 1: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

Note 2:

(a) Device mounted on a glass-epoxy board (a)

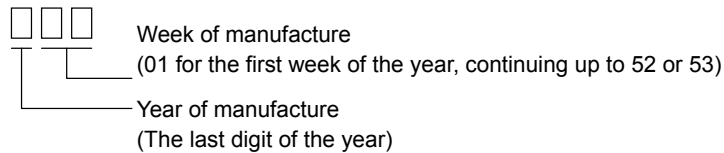
(b) Device mounted on a glass-epoxy board (b)



Note 3:  $V_{DD} = 24\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 0.1\text{ mH}$ ,  $R_G = 25\ \Omega$ ,  $I_{AR} = 35\text{ A}$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: \* Weekly code: (Three digits)

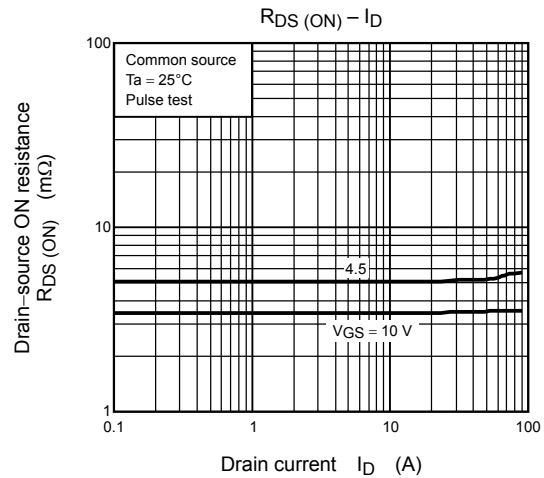
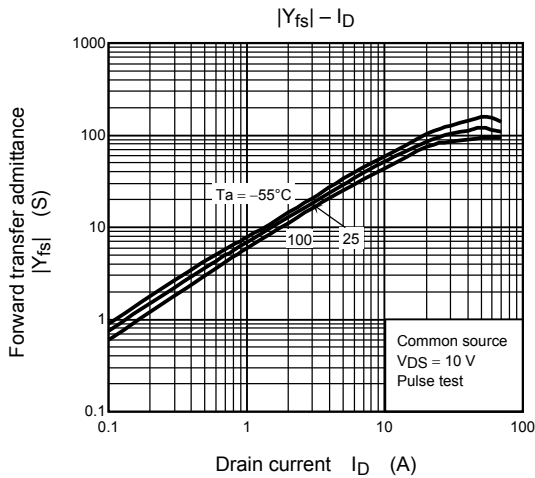
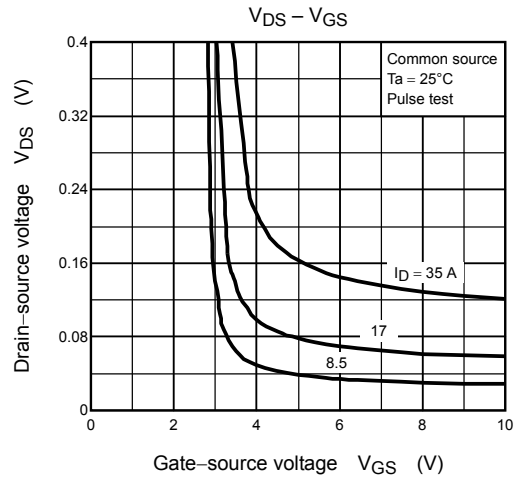
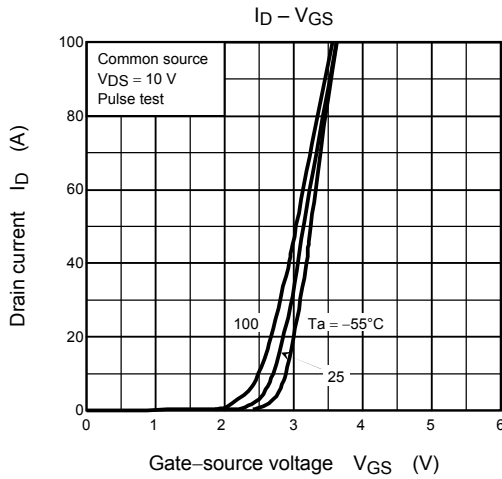
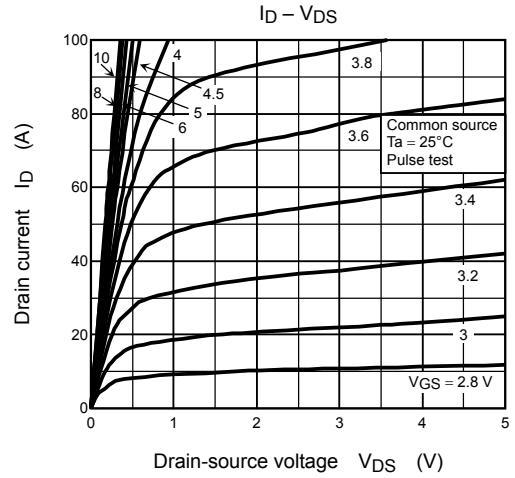
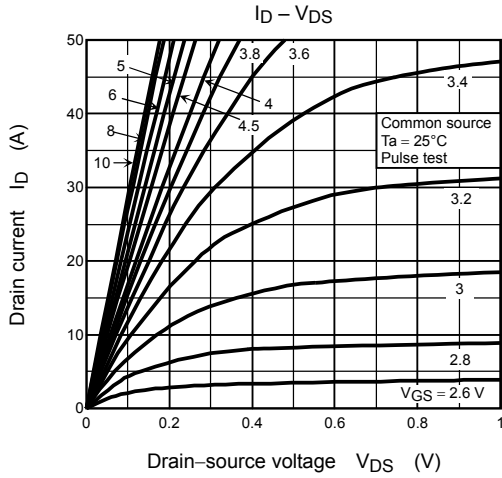


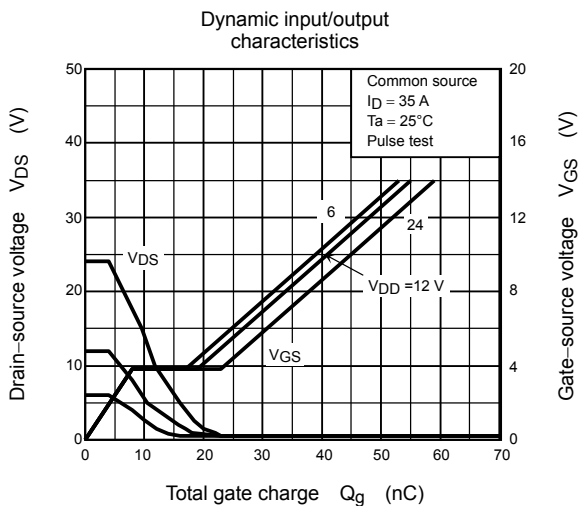
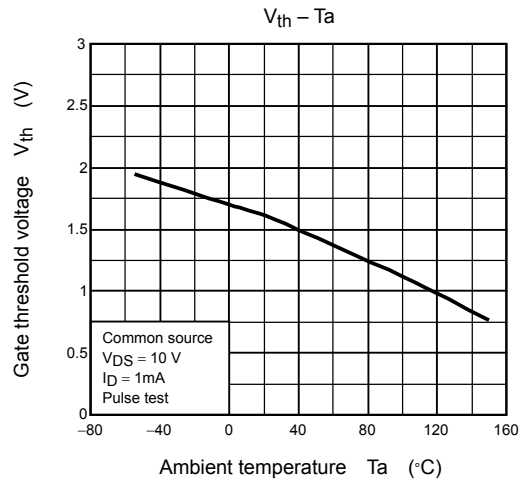
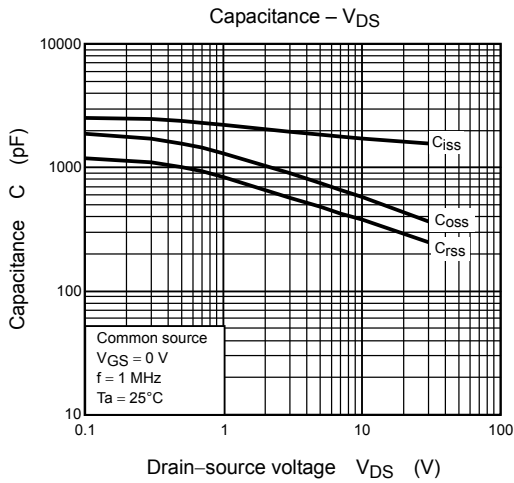
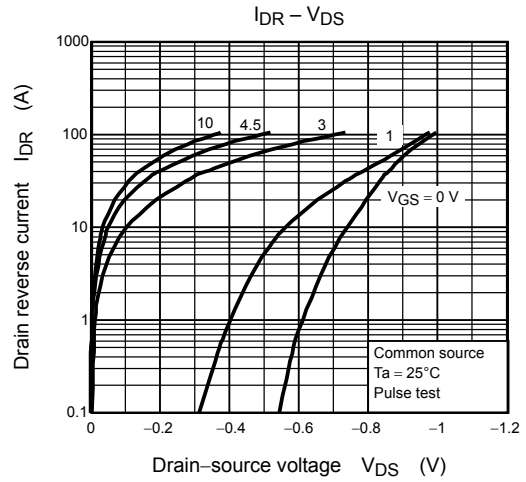
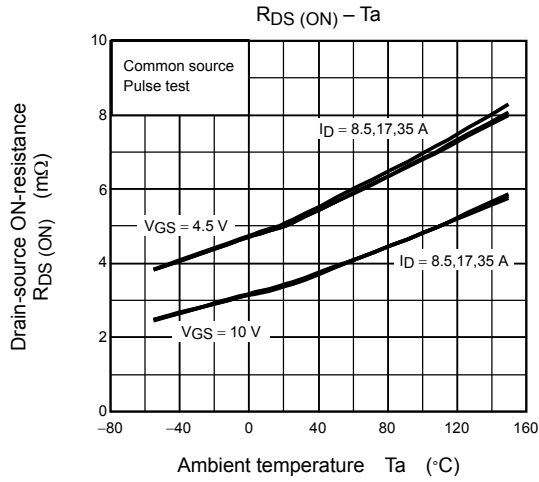
## Electrical Characteristics (Ta = 25°C)

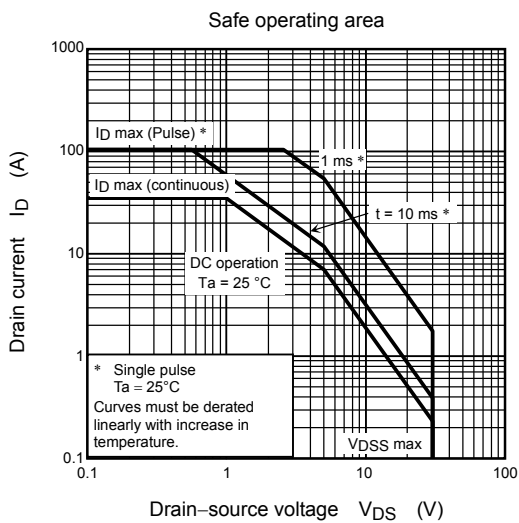
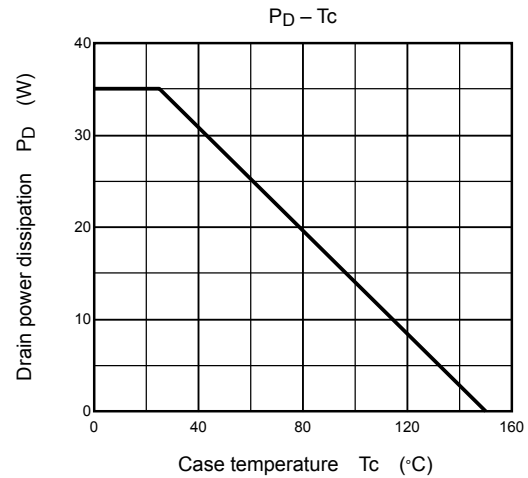
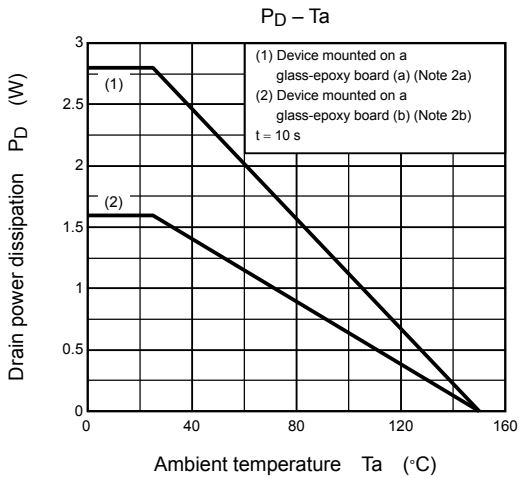
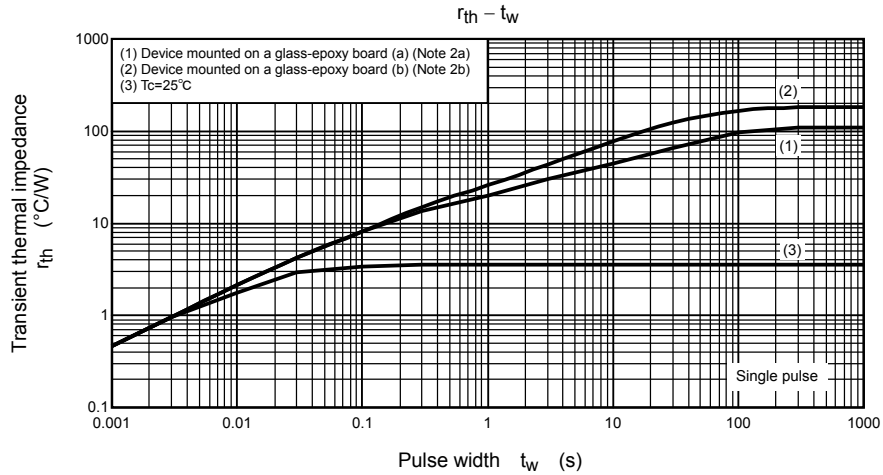
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 100$	nA
Drain cut-OFF current		$I_{DSS}$	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	30	—	—	V
		$V_{(BR) DSX}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$	10	—	—	
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	1.3	—	2.5	V
Drain-source ON-resistance		$R_{DS(ON)}$	$V_{GS} = 4.5\text{ V}, I_D = 17\text{ A}$	—	5.4	7.8	m $\Omega$
			$V_{GS} = 10\text{ V}, I_D = 17\text{ A}$	—	3.5	4.3	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 17\text{ A}$	36	72	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	1800	—	pF
Reverse transfer capacitance		$C_{riss}$		—	370	—	
Output capacitance		$C_{oss}$		—	570	—	
Switching time	Rise time	$t_r$	<p> <math>V_{GS} = 10\text{ V}</math>  <math>0\text{ V}</math>  <math>I_D = 17\text{ A}</math>  <math>V_{OUT}</math>  <math>4.7\ \Omega</math>  <math>0.88\ \Omega</math>  <math>V_{DD} \approx 15\text{ V}</math>                      Duty <math>\leq 1\%</math>, <math>t_w = 10\ \mu\text{s}</math> </p>	—	11	—	ns
	Turn-on time	$t_{on}$		—	19	—	
	Fall time	$t_f$		—	22	—	
	Turn-off time	$t_{off}$		—	64	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 24\text{ V}, V_{GS} = 10\text{ V}, I_D = 35\text{ A}$	—	45	—	nC
Gate-source charge 1		$Q_{gs1}$		—	8	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	15	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	105	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = 35\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.2	V







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